**Microstructural characterization of ordered nickel silicide structures grown on (111) nickel silicide films**

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The formation processes of epitaxial nickel silicides, resulting from the interaction of nickel silicide films (10 nm–100 nm) on (111) silicon (Si) substrates after furnace annealing, have been studied using transmission electron microscopy (TEM) and x-ray diffraction (XRD) techniques. The formation of type-A epitaxial grains (i.e., grown with the same orientation of the underlying Si substrate) and type-B epitaxial grains (i.e., rotated by 180° around the surface normal) in “thick” epitaxial films (i.e., greater than 35 nm) is proposed to be linked to the formation of a fluorite-based CuPt (L1₁)-like NiSi phase. This phase is found to be a metastable phase and is believed to be a transitional phase toward the formation of the equilibrium NiSi₂ phase in both type-A and type-B orientations. In addition, we have found that a fluorite-based CuPt-like NiSi may even coexist with a fluorite-based CuAu I-like structure. The interrelationship between these two structures is discussed in the context of a displacive transformation process in fcc structures as originally proposed by Hansson and Barnes [Acta Metall. 12, 315 (1964)] and Pashley et al. [Philos. Mag. 19, 83 (1969)].

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**I. INTRODUCTION**

Recent studies into the formation mechanisms of epitaxial nickel silicides on (111)Si substrates have shed light onto the unique phase transformation processes that occur. Bennett et al. have shown that the crystalline Ni and δ-Ni₃Si phases (orthorhombic, space group: Pnma) existing as intermediate structures during the formation of NiSi₂ in “thin” epitaxial layers (~8.5 nm). It is concluded that the two phases are not directly involved in the formation of the equilibrium phase, NiSi₂. Gibson et al. have shown in Ultra-High Vacuum (UHV) studies that a transition phase, θ-Ni₃Si (hexagonal, space group hP6), is coupled to the formation of “ultrathin” (i.e., less than 3.5 nm thick) type-A NiSi₂. In their study, dark-field TEM images taken in the early stages of epitaxial formation show areas of θ-Ni₃Si existing within the TEM sample. Upon annealing, type-A NiSi₂ is found to reside in the same location as that of θ-Ni₃Si. Type-B NiSi₂ is observed to form in an extremely rapid manner and encompasses much of the TEM sample. In a more recent study of “thick” (~350 nm) nickel silicide films grown on (111)Si substrates, Ho et al. have shown that ordered metastable epitaxial nickel silicide phases exist prior to the formation of the NiSi₂ phase. Two metastable phases that are found in significant amounts in epitaxial grains are a CaF₂-based CuAu I (L1₀) like structure and a CaF₂-based CuPt (L₁₁-like) structure. It is proposed that the formation of the CuPt-like structure is coupled to the formation of type-A and type-B orientations found in (111) epitaxial nickel silicide films. The authors presented an overview as to the possible unit cell structures of these metastable phases based on TEM electron diffraction analysis. However, little evidence is given concerning: (i) the link between the CuPt-like phase to the two orientations of NiSi₂, and (ii) to the transformation process of the L₁₁-like structure into the L₁₁-like structure. In the present paper, the authors provide additional evidence confirming the existence of the fluorite-based CuPt-like structure in epitaxial films 35 nm–350 nm thick. In addition, a possible transformation mechanism of the CuAu I-like structure into the CuPt-like structure is presented.

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**II. EXPERIMENTAL**

Nickel thin films (10 nm–100 nm) were sputter-deposited onto (111)Si wafers. The thin film-Si composites were then annealed in a three-zone furnace sealed at both ends under a continuous flow of forming gas (90% N₂–10% H₂) or under a 98% Ar–2% H₂ mixture (purity of Ar > 5–9’s). The temperature range of 650 °C–825 °C was chosen in our experiments. A...
the composites were annealed in a furnace, heating rates and cooling rates were generally limited to tens of degrees per minute. Plan-view TEM specimens were prepared by standard techniques and examined in a Phillips EM420 operating at 120 keV. XRD studies were conducted on a Rigaku x-ray diffractometer equipped with a Cu Kα radiation source and a post beam graphite monochromator to filter Kβ radiation intensities.

III. RESULTS

Figure 1(a) is a dark-field micrograph of a 100 nm Ni/(111)Si composite heat-treated for 10 m at 825 °C in a 98% Ar–2% H₂ ambient. The thickness of the nickel silicide film is ~350 nm. The bright regions are epitaxial grains that are of type-B orientation and the dark regions are in type-A orientation. Diffraction patterns from low index poles (i.e., [111]* and [001]*) suggest that these grains are largely composed of NiSi₂. However, if the sample is tilted to the [211]* zone axis, there are superlattice intensities at 1/2 [311] positions (referred to Si) in both type-A and type-B epitaxial NiSi₂ grains [see Fig. 1(b)]. These 1/2 [311] superlattice intensities are observed in the other two (112)*-type zone axis accessible to (111) plan-view specimens, i.e., [121]* and [112]*, in both type-A and type-B epitaxial grains. From simple diffraction calculations, these intensities are not permitted in either of the cubic phases of NiSi₂ or Si. The presence of these superlattice reflections suggests that an ordered epitaxial phase, based on the Si lattice parameter, may be present within the grains.

In electron diffraction studies of plan-view specimens of Ni/(111)Si composites annealed for much longer times (~60 m), these particular reflections are not observed in any (112)*-type diffraction patterns. Electron diffraction suggests that only cubic-NiSi₂ is formed after long anneals. Thus, it is argued that the ordered structure observed in our films, formed after short anneals, is metastable and is a transitional phase during the formation of the equilibrium NiSi₂ phase.

X-ray diffraction studies of Ni/(111)Si samples annealed for 10 m in the temperature range of 650 °C–825 °C also provide evidence of an epitaxial phase present. Figures 2(a) and 2(b) are x-ray diffraction scans of a 100 nm Ni/(111)Si sample annealed for 10 m at 72°C, again under an argon-hydrogen atmosphere. In Fig. 2(a), the x-ray diffraction scan is centered around Bragg angles of 6.5°–8° (2θ = 13°–16°). In Fig. 2(b), the scan is centered around Bragg angles of 13°–15° (2θ = 26°–30°). The high intensity peaks at 2θ ~ 28.5° in Fig. 2(b) correspond to the peaks of (111)Si. The smaller peak to the right of the Si substrate peaks (2θ ~ 28.6°) corresponds to the (111) diffracted intensity of the equilibrium NiSi₂ structure (d₁₁₁ = 3.13 Å). This peak is always observed in samples that have been annealed for extended times (>20 m), and TEM studies of such samples show that only NiSi₂ exists. The small diffuse peak shown in Fig. 2(a) corresponds to an interplanar spacing of ~6.25 Å. This diffracted intensity does not match any interplanar spacings of Si or NiSi₂.
nor does it match any known interplanar spacings of Ni$_2$Si or NiSi. The presence of the diffuse peak is believed to originate from an epitaxial nickel silicide phase that possesses a lattice spacing of 10.8 Å. This conclusion is based on the following line of reasoning: In x-ray scans from $2\theta$ of 10°–140°, only three peaks are present. The peaks are observed at (a) 14.2°, (b) 28.6°, and (c) 58.9°. The latter two diffracted intensities originate from the (111) Si (and NiSi$_2$) and (222) Si (and NiSi$_2$) planes, respectively. For small Bragg angles, the quantity sin $\theta$ approaches that of $\theta$. Thus, the former peak residing at 14.2° is located essentially at half the value of the (111) Si peak. In other words, the diffracted intensity at 14.2° corresponds to a (1/2 1/2 1/2) plane with respect to the silicon lattice. Thus, this particular phase possesses a (111) interplanar spacing twice as large as the (111) spacing for silicon. Hence, the lattice parameter of this epitaxial phase must be twice silicon's lattice parameter (i.e., 10.8 Å).

IV. DISCUSSION

There are two pieces of evidence presented in this work that point to the existence of a metastable epitaxial nickel silicide phase that is produced when annealing thin Ni films with Si: (i) the 1/2 {311} superlattice intensities present in the (112)* electron diffraction patterns, and (ii) the diffuse peak in the x-ray scan at 14.2°. Both of these diffracted intensities cannot be accounted for by the presence of a cubic phase such as Si or NiSi$_2$. From a previous study, a structure that may best explain these results is a CuPt-like NiSi structure, but based on the fluorite structure. Figure 3 shows two of the eight fluorite unit blocks, which fully describes

![Schematic drawing of CuPt-like NiSi structure. Only two of the eight fluorite unit blocks that make up the complete CuPt-like structure are shown.](image_url)
the CuPt-like unit cell structure. The unit blocks, which themselves possess the lattice parameter of Si or NiS2, are stacked in such a way as to double the lattice parameter along the x, y, and z axes. Since the fluorite unit cell contains twelve atoms, the CuPt-like NiSi unit cell contains 96 atoms; thus, the stoichiometry proposed for a perfectly ordered structure is Ni45Si45.

Like its fcc counterpart, the (111) planes of a perfectly ordered CuPt-like structure contain only one atomic species, i.e., Ni or Si. The remaining (111) planes contain a mixture of Ni or Si atoms. Variants of this structure have been observed in other TEM foils. However, the epitaxial grains in Fig. 1(a) show evidence of only a single variant with planes of pure Ni and planes of pure Si on planes parallel to the surface. The stacking of the equilibrium fluorite structure, along the [111] direction, can be written as the following: $A^{ba}B^{cab}C^{ac}A\ldots$ where the underlined capital letters represent Ni atoms located on the fcc Bravais lattice and the small letters represent Si atoms.

![Computer-simulated diffraction patterns of CuPt-like NiSi: (a) [111]*, (b) [011]*, (c) [001]*, and (d) [112]*.](image)

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located at the tetrahedral positions. Nine (111) planes are characteristic of the NiSi₂ structure. The CuPt-like NiSi structure has a lattice parameter twice as large as that of Si. Thus, the CuPt-like structure is characterized by 18 (111) layers. The stacking sequence of the (111) planes is proposed to be (with Ni planes underlined): \( A_b B_byC_{bx} A_b B_byC_{zx} C_{ax} A \ldots \). Moreover, the (111) planes of the CuPt-like NiSi phase may be considered twin planes for this particular structure.\(^6\) One mechanism of creating type B-NiSi is to "twin" a type-A NiSi structure. This can be accomplished through shears of 1/6 (112) on consecutive (111) planes of NiSi.\(^6,7\)

Computer-simulated diffraction patterns originating from the fluorite-based CuPt-like NiSi phase show excellent agreement with the experimentally observed diffraction patterns. Figures 4(a)–(d) are the computer-simulated [111]*, [011]*, [001]*, and [112]* diffraction patterns expected from CuPt-like NiSi.\(^8\) The diffraction patterns in Figs. 4(a)–4(c) of the rhombohedral structure are observed to be "cubic-like." Indeed, from these patterns, one could conclude that the epitaxial grains contained solely NiSi₂. However, the 1/2 {311} reflections in the computer-simulated [112]* diffraction pattern are indicative of the CuPt-like NiSi structure. These particular reflections provide strong evidence that CuPt-like NiSi coexists with NiSi₂ in both type-A and type-B epitaxial grains. Table I lists several reflections that are present for the fluorite-based CuPt-like NiSi phase and the calculated structure factor of these reflections.

Several epitaxial nickel silicide films, produced after annealing for short time periods (~10 m) in the temperature range of 650 °C–825 °C, show evidence of the coexistence of the CuPt-like NiSi phase and the equilibrium NiSi₂ phase. The diffuseness of the (111) diffracted intensities of the NiSi phase is not fully understood presently. One possible explanation may be due to the fact that the long-range order of this phase is partially destroyed; i.e., the (111) planes of the NiSi structure may be partially intermixed. In addition, since the peak does not appear to be as intense as the (111) NiSi₂ diffracted peaks, this observation would suggest that the epitaxial grains consist mostly of NiSi₂ and smaller amounts of NiSi. These arguments are consistent with the explanation that the CuPt-like NiSi phase is a metastable phase for the formation of NiSi₂. Indeed, x-ray diffraction scans of a 10 nm Ni/(111)Si composite annealed for 10 m at 650 °C show that the NiSi phase exists [Fig. 5(a)] but not NiSi₂ [Fig. 5(b)]. Moreover, the metastability of this phase is evident by analyzing films that have been annealed for slightly longer periods. X-ray diffraction scans of Ni/(111)Si samples annealed in the temperature range of 650 °C–825 °C for greater than 10 m show no evidence of the rhombohedral phase, only the presence of cubic-NiSi₂. In summary, it is concluded that the CuPt-like NiSi phase is a metastable transitional phase during the formation of "thick" NiSi₂. Moreover, because the NiSi phase is found early in the stages of epitaxial nickel silicide phase formation, it is

<table>
<thead>
<tr>
<th>NiSi reflection</th>
<th>Reflection referred to Si</th>
<th>Structure factor (F)</th>
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<tbody>
<tr>
<td>(111)</td>
<td>(1/2 1/2 1/2)</td>
<td>( 16[1 - 2i/2] \times [f_{si} - f_{ni}] )</td>
</tr>
<tr>
<td>(311)</td>
<td>(3/2 1/2 1/2)</td>
<td>( 16[f_{si} - f_{ni}] )</td>
</tr>
<tr>
<td></td>
<td></td>
<td>( +2i[4f_{si}(4 + i) + f_{ni}(-16 + i)] )</td>
</tr>
<tr>
<td>(400)</td>
<td>(200)</td>
<td>( -16[f_{si} + f_{ni}] )</td>
</tr>
<tr>
<td>(800)</td>
<td>(400)</td>
<td>( 48[f_{si} + f_{ni}] )</td>
</tr>
</tbody>
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FIG. 5. XRD of 10 nm Ni/(111)Si composite annealed for 10 m at 650 °C: (a) centered around the (111) CuPt-like NiSi peak; (b) centered around the (111) NiSi₂ peak.
proposed that type-A and type-B orientations are linked to the formation of this rhombohedral structure.

The fluorite-based CuPt-like structure that is proposed in the present work appears to substantiate the results of Baeri et al. In their work, they report a thin epitaxial NiSi phase found after pulse laser irradiation. Indeed, strong TEM diffraction evidence was provided to support their hypothesis that the epitaxial material exhibited threefold symmetry. As the diffracted intensities for the rhombohedral NiSi phase proposed in the present work closely resemble those of a cubic material, the rhombohedral NiSi phase may be the material created by Baeri et al. However, one clear difference between the findings of Baeri et al. and that of the present work is the amount of epitaxial NiSi formed. In their films, TEM cross-section micrographs reveal that the entire film is NiSi, whereas the films created in the present work appear to be composed of mostly NiSi₂. The difference in the amount of NiSi formed may be linked to the heating and quenching process of Ni/Si composites. Samples examined in the present work were annealed in a three-zone horizontal furnace. The heating rate to the final annealing temperature and cooling rate back down to room temperature is approximately 10 °C to 50 °C per minute. Heating and cooling rates after laser irradiation is at least three orders of magnitude higher. The rapid thermal annealing and quenching cycle, inherent in the process used by Baeri et al., may have played a large role in creating the epitaxial film of NiSi.

V. TRANSFORMATION OF FLUORITE-BASED CuAu I-LIKE → CuPt-LIKE STRUCTURES

Figure 6(a) is a [110]* diffraction pattern of an epitaxial grain that was created by annealing a 100 nm Ni/(111)Si couple for 10 m at 825 °C in forming gas. The pattern contains 1/2 {111}, 1/2 {100}, and 1/2 {110} reflections (referred to Si) which are not permitted in Si or NiSi₂. The presence of the 1/2 {111} superlattice reflection is indicative of two variants of the fluorite-based CuPt-like NiSi phase. The presence of the 1/2 {100} and 1/2 {110} superlattice reflections reveals the presence of a fluorite-based CuAu I-like structure. Figure 6(b) shows the possible CuAu I-like structure that was previously proposed to coexist with CuPt-like NiSi. This structure is orthorhombic and contains 12 atoms within the unit cell. Previously, it was suggested that the coexistence of the CuAu I-like NiSi and CuPt-like NiSi phases is related to the displacement of Ni or Si along nonequivalent vectors. It was also argued that the CuAu I-like NiSi phase was also a precursor phase to the CuPt-like NiSi phase.

The displacive transformation concept between CuAu I and CuPt—both fcc derivative structures—was originally conceived by Hansson and Barnes and by Pashley et al. Figure 7 shows the displacive transformation mechanism proposed by Hansson and Barnes. In Fig. 7(a), CuAu I unit cells are drawn with the “A” and “B” (111) planes outlined by dashed lines. By displacing gray and white atoms to nonequivalent sites [e.g., via a 1/2 [101] vector on plane “B”; see Fig. 7(b)], the CuAu I unit cell is now transformed into a CuPt structure with (111) layering. Because both CuAu I and CuPt reflections were observed in

\[ \text{FIG. 6. (a) [011]* diffraction pattern of epitaxial nickel silicide grain formed by annealing a 100 nm Ni/(111)Si couple for 10 m at 825 °C in forming gas. (b) Fluorite-based CuAu I-like structure.} \]
FIG. 7. Displacive transformation concept proposed by Hansson and Barnes for CuAu I → CuPt: (a) CuAu I structure sheared on (111) planes by 1/2 [101]; (b) "twinned" CuPt structure.

FIG. 8. Sublattice structure of fluorite.

The [011]* diffraction pattern, it is argued that the displacive transformation model is operative in the thin epitaxial films that we have created. However, the fluorite structure is different from the fcc structure since it contains eight tetrahedral sites that are filled with atoms in addition to the four present on the fcc Bravais lattice. Nonetheless, one can extend the original concept of Hansson and Barnes and Pashley et al. to rationalize the displacive transformation of the fluorite-based CuAu I-like and CuPt-like structures. In order to understand the interrelationship between the two structures, one must first begin by considering the makeup of the fluorite unit cell.

In a strict sense, the CaF$_2$ structure can be considered to consist of four interpenetrating fcc sublattices (see Fig. 8). Here, the atomic positions of the fcc Bravais lattice, $\alpha$, are occupied by black atoms. A second fcc sublattice, $\beta$, is composed of atomic sites at the body center and halfway along the edges of the $\alpha$ sublattice. These sites are occupied by white atoms. The remaining two sublattices, $\delta$ and $\gamma$, consist of atoms occupying the tetrahedral sites of Fig. 8. In the schematic drawing, the atomic positions of the $\delta$ sublattice are occupied by striped atoms and that of the $\gamma$ sublattice are occupied by dotted atoms. The NiS$_2$ structure is constructed by positioning Ni or Si atoms on three of the four sublattices. Ni atoms are positioned on the $\alpha$ sublattice, whereas the Si atoms are positioned on the $\delta$ and $\gamma$ sublattices. The fourth sublattice, $\beta$, may be considered to be occupied by vacancies.

Let us consider the manner in which the sublattices are stacked along the [111] and [111] (i.e., twin) directions. The stacking sequence of the sublattices along the [111] direction, for example, follows the sequence: $\alpha\delta\beta\gamma, \alpha\delta\beta\gamma, \alpha\delta\beta\gamma$, etc. Since in the fluorite structure the $\beta$ sublattice is filled with vacancies, the stacking sequence can be written as $\alpha\delta\gamma, \alpha\delta\gamma, \alpha\delta\gamma$, etc. The stacking of the sublattices along the [111] and [111] directions is important when we try to model the structural transformation of the fluorite-based CuAu I-like and CuPt-like NiSi phases.

The fluorite-based CuAu I-like NiSi structure shown in Fig. 6(b) can be considered to be composed of three interpenetrating fcc-CuAu I units. The CuAu I unit cell
VI. CONCLUSIONS

Summarizing our results, we have presented TEM and x-ray diffraction evidence of a single variant of fluoride-based CuPt-like NiSi. This phase exists within epitaxial grains of nickel silicide films after annealing 10–100 nm Ni/(111)Si composites for 10 m in the temperature range of 650 °C–825 °C. The CuPt-like NiSi phase is found only in the early stages of epitaxial film formation. The results in the present work, primarily obtained by electron diffraction and x-ray diffraction, strongly suggest that the type-A and type-B orientations in “thick” (>35 nm) (111) nickel silicide epitaxial films are linked to the formation of “untwinned” and “twinned” CuPt-like NiSi phases. Moreover, the coexistence of fluoride-based CuAu I-like and CuPt-like BiSi has been observed in some TEM samples. A displacive transformation process, based on a model proposed by Hansson and Barnes and Pashley et al., is proposed to occur in these fluoride-derivative structures.

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